

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCT08AF, TC74VHCT08AFK

#### Quad 2-Input AND Gate

The TC74VHCT08A is an advanced high speed CMOS 2-INPUT AND GATE fabricated with silicon gate  $C^2$ MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The input voltage are compatible with TTL output voltage.

This device may be used as a level converter for interfacing 3.3 V to 5 V system.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output <sup>(Note)</sup> pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

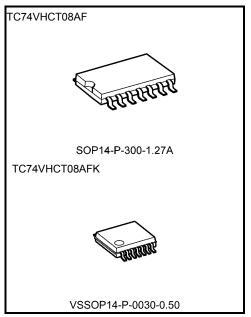
Note: VCC = 0 V

#### **Features**

- High speed: tpd = 5.0 ns (typ.) at VCC = 5 V
- Low power dissipation: ICC = 2 μA (max) at Ta = 25°C
- Compatible with TTL inputs: VIL = 0.8 V (max)

VIH = 2.0 V (min)

- Power down protection is provided on all inputs and outputs.
- Balanced propagation delays: tpLH ≈ tpHL
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 08 type.



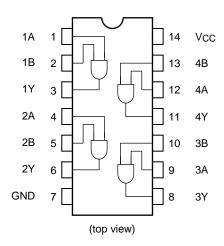
Weight

SOP14-P-300-1.27A : 0.18 g (typ.) VSSOP14-P-0030-0.50 : 0.02 g (typ.)

Start of commercial production 1995-12



#### **Pin Assignment**



#### **IEC Logic Symbol**

1A —	(1)	&	(3) 1Y
1B —	(2)		
2A —	(4)		(6) 2Y
2B —	(5)		2Y
3A —	(9)		(8) <sub>3Y</sub>
3B —	(10)		<del>(8)</del> 3Y
4A —	(12)		(11)
4B —	(13)		(11) 4Y

#### **Truth Table**

Α	В	Υ		
L	L	L		
L	Н	L		
Н	L	L		
Н	Н	Н		

### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	−0.5 to 7.0	V
DC input voltage	VIN	−0.5 to 7.0	V
DC output voltogo	Vour	-0.5 to 7.0 (Note 2)	V
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	lıĸ	-20	mA
Output diode current	lok	±20 (Note 4)	mA
DC output current	lout	±25	mA
DC Vcc/ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: VCC = 0 V

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC



# **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	4.5 to 5.5	V
Input voltage	VIN	0 to 5.5	٧
Output voltage	Vour	0 to 5.5 (Note 2)	V
Output voltage	Vout	0 to Vcc (Note 3)	V
Operating temperature	Topr	−40 to 85	°C
Input rise and fall time	dt/dV	0 to 20	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: VCC = 0 V

Note 3: High or low state.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition VCC (V)		Ta = 25°C			Ta = −40 to 85°C		Unit	
Characteriotics	Cymbol			Vcc (V)	Min	Тур.	Max	Min	Max	01111
High-level input voltage	VIH	_		4.5 to 5.5	2.0	١	_	2.0	_	V
Low-level input voltage	VIL	_		4.5 to 5.5	_	-	0.8	_	0.8	V
High-level output	Voн	$V_{IN} = V_{IH}$	I <sub>OH</sub> = -50 μA	4.5	4.40	4.50	_	4.40	_	V
voltage			I <sub>OH</sub> = -8 mA	4.5	3.94	_	_	3.80	_	
Low-level output	VoL	VIN = VIH or VIL	$I_{OL} = 50 \mu A$	4.5	_	0.0	0.1	_	0.1	V
voltage			I <sub>OL</sub> = 8 mA	4.5	_	_	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V (	or GND	0 to 5.5	_	_	±0.1	_	±1.0	μА
	Icc	VIN = VCC or GND		5.5	_	_	2.0	-	20.0	μΑ
Quiescent supply current	Ісст	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	_	_	1.35	_	1.50	mA
Output leakage current (Power-OFF)	IOPD	V <sub>OUT</sub> = 5.5 V		0	1	1	0.5	_	5.0	μА



### AC Characteristics (input: tr = tf = 3 ns)

Characteristics	Symbol	Tes	st Condition		Ta = 25°C			Ta = -40 to 85°C		- Unit
onaraotonous	<b>G</b> y50.		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	O TIIL
Propagation delay	t <sub>pLH</sub> t <sub>pHL</sub>	_	5.0 ± 0.5	15	_	5.0	6.9	1.0	8.0	ns
time				50	_	5.5	7.9	1.0	9.0	
Input capacitance	CIN	_			_	4	10	_	10	pF
Power dissipation capacitance	CPD	(No		(Note)	- 1	18	_	- 1	1	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/4 (per gate)

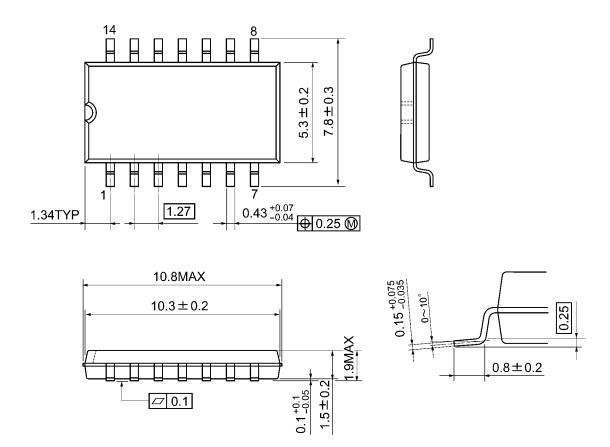
### Noise Characteristics (input: tr = tf = 3 ns)

Charactaristics	Comme la sal	Test Condition	Ta =	1.1-21		
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Limit	Unit
Quiet output maximum dynamic VOL	VOLP	C <sub>L</sub> = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic VoL	Volv	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	V
Minimum high level dynamic input voltage	VIHD	C <sub>L</sub> = 50 pF	5.0	_	2.0	V
Maximum low level dynamic input voltage	VILD	C <sub>L</sub> = 50 pF	5.0	1	0.8	V



# **Package Dimensions**

SOP14-P-300-1.27A Unit: mm

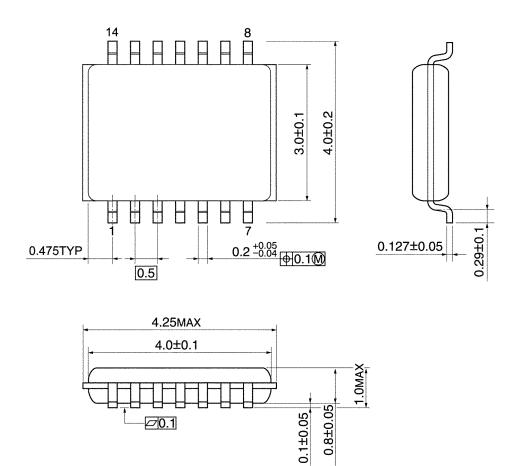


Weight: 0.18 g (typ.)



# **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)



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